

Substitute for form 1449A/B/PTO			Complete if Known		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use as many sheets as necessary)			Application Number	Not Yet Assigned W/714,966	
			Filing Date	Concurrently Herewith 11/18/03	
			First Named Inventor	Cyril Cabral, Jr. et al.	
			Art Unit	W/A 2211	
			Examiner Name	Not Yet Assigned HUNG JU	
Sheet	1	of	1	Attorney Docket Number	YOR920030287US1(20140-00308)

U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	Document Number Number-Kind Code ² (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
✓	AA	US-2003/0075808	04-24-2003	Inoue	-
✓	AB	US-6342733	01-29-2002	Hu, et al.	-
✓	AC	US-6573606	06-03-2003	Sambucetti, et al.	-
✓	AD	US-6528409	03-04-2003	Lopatin, et al.	-
✓	AE	US-6323128	11-27-2001	Sambucetti, et al.	-
✓	AF	US-2003/0010645	01-16-2003	Ting, et al.	-
✓	AG	US-5895810	12-09-1997	Dubin, et al.	-

FOREIGN PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	Foreign Patent Document Country Code ² -Number ³ -Kind Code ⁴ (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. ¹Applicant's unique citation designation number (optional). ²See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached.

NON PATENT LITERATURE DOCUMENTS				
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.		
✓	CA	A. KOHN, et al., "Characterization of electroless deposited Co(W,P) thin films for encapsulation of copper metallization" Materials Science and Engineering A302 (2001) pages 18-25		
✓	CB	C.-K. HU, et al., "Reduced electromigration of Cu wires by surface coating" IBM T.J. Watson Research Center, Yorktown Heights, New York 2002		
✓	CC	P.L. CAVALLOTTI, et al., "Microelectrodeposition of cobalt and its alloys" Proceedings AESF SUR/FIN Annual International Technical Conference, 1999, pages 325-335		
✓	CD	C.-K. HU, et al., "Electromigration in On-Chip Single/Dual Damascene Cu Interconnections" Journal of the Electrochemical Society, Vol. 149, No. 7, pages 408-415, 2002		

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Examiner Signature	HUNG JU	Date Considered	10/21/04
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